

RQ-40G-ZE4

40Gb/s 1310nm ZR4 80km QSFP+ Transceiver Hot Pluggable, Duplex LC Connector, Single mode

Features:

- 4 lanes MUX/DEMUX design
- Integrated LAN WDM TOSA / ROSA
- ◆ Up to 11.2Gbps per channel bandwidth
- Aggregate bandwidth of > 40Gbps
- Duplex LC connector
- Compliant with 40G Ethernet IEEE802.3ba and 40GBASE-ZR4
- QSFP MSA compliant
- APD photo-detector
- Up to 80 km transmission
- Compliant with QDR/DDR Infiniband data rates
- Single +3.3V power supply operating
- Built-in digital diagnostic functions
- Temperature range 0°C to 70°C
- RoHS Compliant Part

Applications:

- Rack to rack
- Data centers Switches and Routers
- Metro networks
- Switches and Routers
- 40G BASE-ZR4

Description:

The RQ-40G-ZE4 is a transceiver module designed for 80km optical communication applications. The design is compliant to 40GBASE-ZR4 of the IEEE P802.3ba standard. The module converts 4





inputs channels of 10Gb/s electrical data to 4 LWDM optical signals, and multiplexes them into a single channel for 40Gb/s optical transmission. Reversely, on the receiver side, the module optically de-multiplexes a 40Gb/s input into 4 LWDM channels signals, and converts them to 4 channel output electrical data.

The central wavelengths of the 4 LANWDM channels are 1296 nm, 1300 nm, 1305 nm and 1309 nm as members of the LAN WDM wavelength grid defined in ITU-T G694.2. It contains a duplex LC connector for the optical interface and a 38-pin connector for the electrical interface. To minimize the optical dispersion in the long-haul system, single-mode fiber (SMF) has to be applied in this module.

The product is designed with form factor, optical/electrical connection and digital diagnostic interface according to the QSFP Multi-Source Agreement (MSA). It has been designed to meet the harshest external operating conditions including temperature, humidity and EMI interference. The module operates from a single +3.3V power supply and LVCMOS/LVTTL global control signals such as Module Present, Reset, Interrupt and Low Power Mode are available with the modules. A 2-wire serial interface is available to send and receive more complex control signals and to obtain digital diagnostic information. Individual channels can be addressed and unused channels can be shut down for maximum design flexibility.

The TQP10 is designed with form factor, optical/electrical connection and digital diagnostic interface according to the QSFP Multi-Source Agreement (MSA). It has been designed to meet the harshest external operating conditions including temperature, humidity and EMI interference. The module offers very high functionality and feature integration, accessible via a two-wire serial interface.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Typical	Max.	Unit
Storage Temperature	Ts	-40		+85	°C
Supply Voltage	V _{CC} T, R	-0.5		4	V
Relative Humidity	RH	0		85	%

• Recommended Operating Environment:

Parameter	Symbol	Min.	Typical	Max.	Unit
Case operating Temperature	T _C	0		+70	°C
Supply Voltage	V _{CCT, R}	+3.13	3.3	+3.47	V
Supply Current	I _{cc}			1000	mA
Power Dissipation	PD			3.5	W

■ Electrical Characteristics (T_{OP} = 0 to 70 °C, VCC = 3.13 to 3.47 Volts

Parameter	Symbol	Min	Тур	Max	Unit	Note
Data Rate per Channel		ı	10.3125	11.2	Gbps	



Power Consumption		-	2.5	5	W	
Supply Current	lcc		0.75	1.3	Α	
Control I/O Voltage-High	VIH	2.0		Vcc	V	
Control I/O Voltage-Low	VIL	0		0.7	V	
Inter-Channel Skew	TSK			150	Ps	
RESETL Duration			10		Us	
RESETL De-assert time				100	ms	
Power On Time				100	ms	
Transmitter						
Single Ended Output Voltage Tolerance		0.3		4	V	1
Common mode Voltage Tolerance		15			mV	
Transmit Input Diff Voltage	VI	150		1200	mV	
Transmit Input Diff Impedance	ZIN	85	100	115		
Data Dependent Input Jitter	DDJ		0.3		UI	
Receiver						
Single Ended Output Voltage Tolerance		0.3		4	V	
Rx Output Diff Voltage	Vo	370	600	950	mV	
Rx Output Rise and Fall Voltage	Tr/Tf			35	ps	1
Total Jitter	TJ		0.3		UI	

Note:

1. 20~80%

Optical Parameters(TOP = 0 to 70 °C, VCC = 3.0 to 3.6 Volts)

Parameter	Symbol	Min	Тур	Max	Unit	Ref.
Transmitter						
	LO	1294.53	1295.56	1296.59	nm	
	L1	1299.02	1300.05	1301.09	nm	
Wavelength Assignment	L2	1303.54	1304.58	1305.63	nm	
	L3	1308.09	1309.14	1310.19	nm	
Side-mode Suppression Ratio	SMSR	30	-	-	dB	
Total Average Launch Power	PT		-	10.5	dBm	
Average Launch Power, each Lane		+4	-	7	dBm	
Transmit OMA per Lane	TxOMA	0.3		5.0	dBm	
Difference in launch power between any two lanes (OMA)				4.7	dBm	
Transmitter Dispersion Penalty each Lane	TDP			2.6	dB	



Extinction Ratio	ER	5.5	6.5		dB	
		{0.25, 0.4,				
Transmitter Eye Mask Definition {X1,		0.45,				
X2, X3, Y1, Y2, Y3}		0.25,				
		0.28, 0.4}				
Optical Return Loss Tolerance		-	-	20	dB	
Average Launch Power OFF Transmitter, each Lane	Poff			-30	dBm	
Relative Intensity Noise	Rin			-128	dB/HZ	1
Optical Return Loss Tolerance		-	-	12	dB	
Receiver						
Damage Threshold	THd	0			dBm	1
Average Power at Receiver Input, each Lane	R	-24		-6	dBm	
Receive Electrical 3 dB upper Cut off Frequency, each Lane				12.3	GHz	
RSSI Accuracy		-2		2	dB	
Receiver Reflectance	Rrx			-26	dB	
Receiver Power (OMA), each Lane		-	-	-4	dBm	
Receive Electrical 3 dB upper Cutoff Frequency, each Lane				12.3	GHz	
LOS De-Assert	LOS _D			-25	dBm	
LOS Assert	LOS _A	-35			dBm	
LOS Hysteresis	LOS _H	0.5			dB	

Note

1. 12dB Reflection

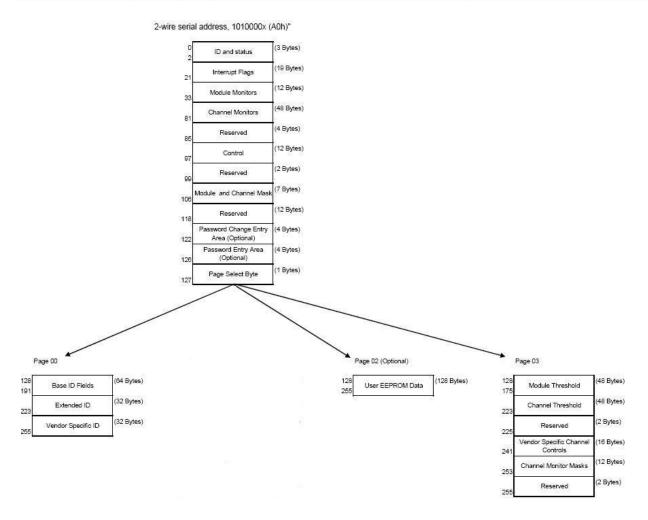
Diagnostic Monitoring Interface

Digital diagnostics monitoring function is available on all QSFP+ ER4. A 2-wire serial interface provides user to contact with module. The structure of the memory is shown in flowing. The memory space is arranged into a lower, single page, address space of 128 bytes and multiple upper address space pages. This structure permits timely access to addresses in the lower page, such as Interrupt Flags and Monitors. Less time critical time entries, such as serial ID information and threshold settings, are available with the Page Select function. The interface address used is A0xh and is mainly used for time critical data like interrupt handling in order to enable a one-time-read for all data related to an interrupt situation. After an interrupt, IntL has been asserted, the host can read out the flag field to determine the affected channel and type of flag.



Byte Address	Description	Туре
0	Identifier (1 Byte)	Read Only
1-2	Status (2 Bytes)	Read Only
3-21	Interrupt Flags (31 Bytes)	Read Only
22-33	Module Monitors (12 Bytes)	Read Only
34-81	Channel Monitors (48 Bytes)	Read Only
82-85	Reserved (4 Bytes)	Read Only
86-97	Control (12 Bytes)	Read/Write
98-99	Reserved (2 Bytes)	Read/Write
100-106	Module and Channel Masks (7 Bytes)	Read/Write
107-118	Reserved (12 Bytes)	Read/Write
119-122 Reserved (4 Bytes)		Read/Write
123-126	Reserved (4 Bytes)	Read/Write
127	Page Select Byte	Read/Write

Byte Address Description		Туре	
128-175	Module Thresholds (48 Bytes)	Read Only	
176-223 Reserved (48 Bytes)		Read Only	
224-225	Reserved (2 Bytes)	Read Only	
226-239	Reserved (14 Bytes)	Read/Write	
240-241	Channel Controls (2 Bytes)	Read/Write	
242-253	Reserved (12 Bytes)	Read/Write	
254-255	Reserved (2 Bytes)	Read/Write	





EEPROM Serial ID Memory Contents (A0h)

Data	Length	Name of	Description and Contents
Address	(Byte)	Length	•
Base ID Fi		I	
128	1		Identifier Type of serial Module(D=QSFP+)
129	1		Extended Identifier of Serial Module(90=2.5W)
130	1		Code of connector type(7=LC)
131-138	8	l .	Code for electronic compatibility or optical compatibility(40GBASE-LR4)
139	1	Encoding	Code for serial encoding algorithm(5=64B66B)
140	1	BR, Nominal	Nominal bit rate, units of 100 MBits/s(6C=108)
141	1	Extended rateselect Compliance	Tags for extended rate select compliance
142	1	Length(SMF)	Link length supported for SMF fiber in km (28=80km)
143	1	Length(OM3 50um)	Link length supported for EBW 50/125um fiber(OM3), units of 2m
144	1	Length(OM2 50um)	Link length supported for 50/125um fiber(OM2), units of 1m
145	1	Length(OM1 62.5um)	Link length supported for 62.5/125um fiber (OM1), units of 1m
146	1	Length(Coppe r)	Link length of copper or active cable, unites of 1m Link length supported for 50/125um fiber (OM4), units of 2m when Byte 147 declares 850nm VCSEL as defined in Table 37
147	1	Device tech	Device technology
148-163	16	Vendor name	QSFP+ vendor name: FIBERWDM (ASCII)
164	1	Extended Module	Extended Module codes for InfiniBand
165-167	3	Vendor OUI	QSFP+ vendor IEEE company ID(000840)
168-183	16	Vendor PN	Part number: RQ-40G-ZR4 (ASCII)
184-185	2	Vendor rev	Revision level for part number provided by vendor (ASCII) (X1)
186-187	2	Wave length or Copper cable Attenuation	Nominal laser wavelength (wavelength=value/20 in nm) or copper cable attenuation in dB at 2.5GHz (Adrs 186) and 5.0GHz (Adrs 187) (65A4=1301)
188-189	2	_	Guaranteed range of laser wavelength(+/- value) from nominal wavelength. (wavelength Tol.=value/200 in nm) (1C84=36.5)
190	1	Max case temp.	Maxinum case temperature in degrees C (70)
191	1	CC_BASE	Check code for base ID fields (addresses 128-190)
Extended	ID fields		



192-195	4	Options	Rate Select, TX Disable, Tx Fault, LOS, Warning indicators for: Temperature, VCC, RX, power, TX Bias			
196-211	16	Vendor SN	Serial number provided by vendor (ASCII)			
212-219	8	Date Code	Vendor's manufacturering date code			
		Diagnostic	Indicates which types of diagnostic monitoring are implemented (if			
220	1	Monitoring	any) in the Module. Bit 1, 0 Reserved (8=Average Power)			
		Type				
221	1	Enhanced	Indicates which optional enhanced features are implemented in the			
221	1	Options	Module.			
222	1	Reserved				
223	1	CC_EXT	Check code for the Extended ID Fields (addresses 192-222)			
Vendor S	Vendor Specific ID Fields					
224-255	32 Vendor Specific EEPROM					

• Timing for Soft Control and Status Functions

Parameter	Symbol	Max	Unit	Conditions
		2000		Time from power on1, hot plug or rising
Initialization Time	t_init	2000	ms	edge of Reset until the module is fully
				functional2
				A Reset is generated by a low level longer
Reset Init Assert Time	t_reset_init	2	μs	than the minimum reset pulse time present
				on the ResetL pin.
Serial Bus Hardware				Time from power on1 until module responds
Ready Time	t_serial	2000	ms	to data transmission over the 2-wire serial
Ready Time				bus
Monitor Data Ready	t data	2000	mc	Time from power on1 to data not ready, bit
Time	t_data	2000	ms	0 of Byte 2, deasserted and IntL asserted
Dood Assaut Times	t_reset	2000	ms	Time from rising edge on the ResetL pin until
Reset Assert Time				the module is fully functional2
				Time from assertion of LPMode
LPMode Assert Time	ton_LPMode	100	μs	(Vin:LPMode =Vih) until module power
				consumption enters lower Power Level
IntL Assert Time	ton Intl	200	mc	Time from occurrence of condition
IIIL ASSERT TIME	ton_IntL	200	ms	triggering IntL until Vout:IntL = Vol
				toff_IntL 500 μs Time from clear on read3
IntL Deassert Time	toff Intl	500		operation of associated flag until Vout:IntL =
inte Deassert Time	toff_IntL	300	μs	Voh. This includes deassert times for Rx LOS,
				Tx Fault and other flag bits.
Rx LOS Assert Time	ton los	100	mc	Time from Rx LOS state to Rx LOS bit set and
LY FOR ASSELL LILLE	1011_105	100	ms	IntL asserted



Flag Assert Time	ton_flag	200	ms	Time from occurrence of condition triggering flag to associated flag bit set and IntL asserted
Mask Assert Time	ton_mask	100	ms	Time from mask bit set4 until associated IntL assertion is inhibited
Mask De-assert Time	toff_mask	100	ms	Time from mask bit cleared4 until associated IntlL operation resumes
ModSelL Assert Time	ton_ModSel L	100	μs	Time from assertion of ModSelL until module responds to data transmission over the 2-wire serial bus
ModSelL Deassert Time	toff_ModSel L	100	μs	Time from deassertion of ModSelL until the module does not respond to data transmission over the 2-wire serial bus
Power_over-ride or Power-set Assert Time	ton_Pdown	100	ms	Time from P_Down bit set 4 until module power consumption enters lower Power Level
Power_over-ride or Power-set De-assert Time	toff_Pdown	300	ms	Time from P_Down bit cleared4 until the module is fully functional3

Note:

- 1. Power on is defined as the instant when supply voltages reach and remain at or above the minimum specified value.
- 2. Fully functional is defined as IntL asserted due to data not ready bit, bit 0 byte 2 de-asserted.
- 3. Measured from falling clock edge after stop bit of read transaction.
- 4. Measured from falling clock edge after stop bit of write transaction.

Transceiver Block Diagram

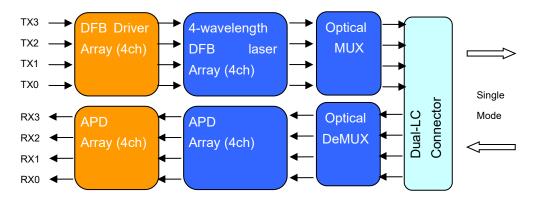


Figure 1: 40Gb/s QSFP ER4 Transceiver Block Diagram

Pin Assignment



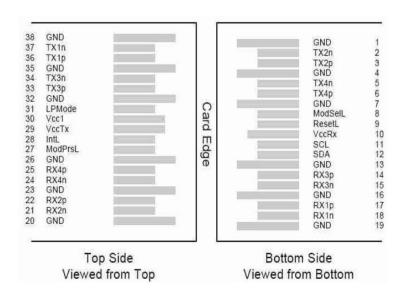


Diagram of Host Board Connector Block Pin Numbers and Name

Pin Description

Pin	Logic	Symbol	Name/Description	Ref.
1		GND	Ground	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	
3	CML-I	Tx2p	Transmitter Non-Inverted Data output	
4		GND	Ground	1
5	CML-I	Tx4n	Transmitter Inverted Data Output	
6	CML-I	Тх4р	Transmitter Non-Inverted Data Output	
7		GND	Ground	1
8	LVTTL-I	ModSelL	Module Select	
9	LVTTL-I	ResetL	Module Reset	
10		VccRx	+3.3V Power Supply Receiver	2
11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock	
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data	
13		GND	Ground	1
14	CML-O	Rx3p	Receiver Inverted Data Output	
15	CML-O	Rx3n	Receiver Non-Inverted Data Output	
16		GND	Ground	1
17	CML-O	Rx1p	Receiver Inverted Data Output	
18	CML-O	Rx1n	Receiver Non-Inverted Data Output	
19		GND	Ground	1
20		GND	Ground	1
21	CML-O	Rx2n	Receiver Inverted Data Output	
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	



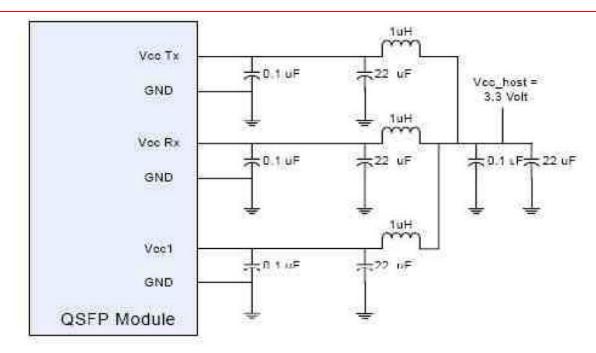
23		GND	Ground	1
24	CML-O	Rx4n	Receiver Inverted Data Output	
25	CML-O	Rx4p	Receiver Non-Inverted Data Output	
26		GND	Ground	1
27	LVTTL-O	ModPrsL	Module Present	
28	LVTTL-O	IntL	Interrupt	
29		VccTx	+3.3V Power Supply Transmitter	2
30		Vcc1	+3.3V Power Supply	2
31	LVTTL-I	LPMode	Low Power Mode	
32		GND	Ground	1
33	CML-I	Тх3р	Transmitter Inverted Data Output	
34	CML-I	Tx3n	Transmitter Non-Inverted Data Output	
35		GND	Ground	1
36	CML-I	Tx1p	Transmitter Inverted Data Output	
37	CML-I	Tx1n	Transmitter Non-Inverted Data Output	
38		GND	Ground	1

Notes:

- GND is the symbol for single and supply(power) common for QSFP modules, All are common within the QSFP module and all module voltages are referenced to this potential otherwise noted. Connect these directly to the host board signal common ground plane. Laser output disabled on TDIS >2.0V or open, enabled on TDIS <0.8V.
- 2. VccRx, Vcc1 and VccTx are the receiver and transmitter power suppliers and shall be applied concurrently. Recommended host board power supply filtering is shown below. VccRx, Vcc1 and VccTx may be internally connected within the QSFP transceiver module in any combination. The connector pins are each rated for maximum current of 500mA.

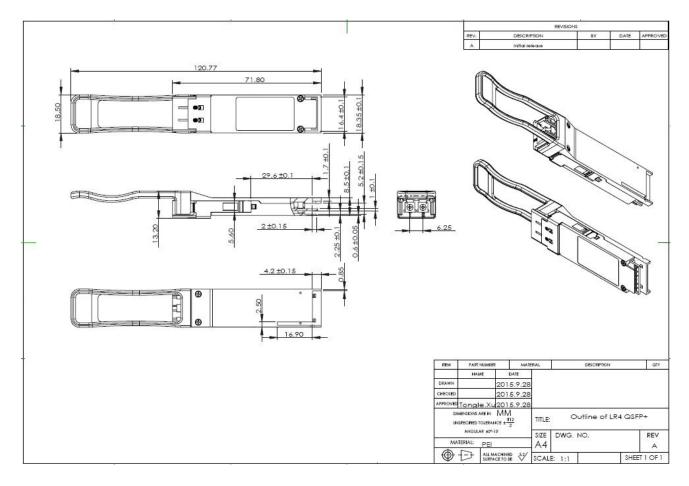
Recommended Circuit







Mechanical Dimensions



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